Uni-Seal™ 3718F



UV/Visible/Heat/Activator Curable Flexible Low Shrink Encapsulant

PRODUCT DESCRIPTION

Incure Uni-Seal™ 3718F UV/Visible/LED curable adhesive is a encapsulant for electronic components on printed circuit boards. Product can be cured in seconds, with optional secondary heat cure. Exhibits low stress and low shrinkage properties during cure and is often used as a moisture barrier for sensitive components. Formulated with enhanced moisture and temperature resistance, with fluorescing feature to aid inspection. It is 100% solids, contains no volatiles and it is ideal for product requiring thermal cycling.

UNCURED PROPERTIES

Chemical Type	Urethane Acrylate, 100% Solids, No Solvents					
Appearance	Single Component, Slightly Translucent					
Density, g/ml	1.08	, , , , ,			@20°C	
Flash Point, °C	> 93	Toxicity Low (Refer to MSDS)				
Viscosity, cP (rpm)	20	10,000 -	18,000	Spindle	6	
Other viscosities are a viscosity range reque this product may be p Email us at: support@local distributor for mo	offering, b fee.	ASTM	D2556			

¹ Viscosity (cP) taken at 25°C - Call to enquiry for other viscosities.

CURED PROPERTIES

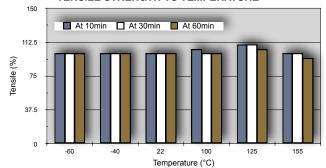
Shore Hardness, Dur	ometer	D40 to D50	ASTM 2240	
Linear Shrinkage / Ex	rpansion (-ve)	0.70%	ASTM 570	
Water Absorption at 2	24hrs	0.60%	² ISTM D2566	
Tensile (PSI)	PC-PC / SS-SS	2,400* / 4,400*	ASTM 638	
* PC-PC / SS-SS / S-S / AL-AL * PC Substrate Failure	S-S / AL-AL	4,000* / 5,200*		
Surface After Full Cu	re	Tack-Free	² ISTM D189	
Elongation at Break		254%	ASTM 638	
Thermal Range (Britt	leness / Degrades) °C	0.00%	² ISTM D366	
Young's Modulus of E	Elasticity, MPa (PSI)	25 (3,700)	³ ASTM 638	
Average Linear CTE,	ppm/°C	86	² ISTM D696	

RECOMMENDED UV CURE SCHEDULE (FULL CURE)

Full Cure Exposure Time			UVA	UVB	UVC	UVV
Fixture Time between glass slides		mW/cm ²	150	43	5	140
Exposure Time (s)	1.0	mJ/cm ²	150	43	5	140
F200P™ @3.75" Dist	5.0	mW/cm ²	150	43	5	140
Belt Speed (ft/min)	1.5	mJ/cm ²	750	215	25	700
F500™ @3.0" Dist	3.0	mW/cm ²	500	160	15	480
Belt Speed (ft/min)	1.5	mJ/cm ²	1,500	480	45	1,440
S20™ Spot (4-Pole LG) 0.4" Dist		mW/cm ²	3,000	530	50	3,400
Exposure Time (s)	1.0	mJ/cm ²	3,000	530	50	3,400
L9000™ LED Spot @ 0.67" Dist		mW/cm ²	2,800	42	12	102
Exposure Time (s)	1.0	mJ/cm ²	2,800	42	12	102

Cure times on 8mm ø adhesive sample. Belt speeds using C9000-F200Px1AB (Flood) and C9000-F500x1AC (Focused Beam) conveyors for area curing. Please consult IncureLab™ for any other requirements

TENSILE STRENGTH VS TEMPERATURE



UV INTENSITY REFERENCE TABLE

Incure UV Curing Lamp Model	⁴ Curing Distance vs UV Intensity					
Spot Curing (ø mm)	0.5" (12.6)	1" (25.4)	1.5" (38)	2" (50.8)	2.5" (63.5)	3" (76.2)
S20™ ARC (mW/cm²) / (ø mm)	1,400 (3)	1,500 (4)	650 (6)	360 (8)	240 (10)	175 (12)
L9000™ LED (mW/cm²) / (ø mm)	7,500 (9)	5,000 (10)	2,300 (17)	1,200 (20)	700 (25)	450 (30)
Flood/Focus Beam - Area Curing	UV Intensity (mW/cm²)					
F200™ ARC Flood (6" x 8")	325	280	245	215	190	165
F400™ ARC Flood (4" x 4")	860	570	440	345	270	215
F500™ ARC Focused (3" x 5")	1,040	685	530	415	325	260
L1044-365™ LED Flood (4" x 4")	2,675	2,380	1,900	1,625	1,430	1,280
L1044-405™ LED Flood (4" x 4")	2,950	2,625	2,150	1,900	1,650	1,450
⁴ Curing Distance is defined by the tip of light-guide or base of lamp housing to the bond area. All values are nominal with ±10%						

on, with LED Flood Static Uniformity at ±78% and Dynamic Uniformity at ±90%. Recommended curing parameters in grey

SECONDARY HEAT CURE SCHEDULE

Continuous Oven Bake	Duration
95°C (203°F)	120 mins
110°C (230°F)	60 mins
125°C (257°F)	30 mins

Incure, Inc.

1 Hartford Square, Box 16 West. Suite C-3, New Britain, CT 06052, USA Tel: (860) 748 2979 support@uv-incure.com

RoHS Pb HF

Incure Adhesives Manufacturing Pte Ltd 33 Ubi Avenue 3 #04-23,

Vertex Tower B, Singapore 408868 Tel: (65) 6509 3670 www.uv-incure.com

UV CURING SCHEDULE FOR THIS PRODUCT

Wavength λ	UVA (320 - 400nm)	UVB (290-320nm)	UVC (290-220nm)	VUV (400-700nm)	Note: This product has been thoroughly tested to cure with F200P™ UV Flood Lamp.
Minimum Intensity	150 mW/cm ²	43 mW/cm ²	5 mW/cm ²	140 mW/cm ²	Intensity wavelengths (shaded) are crucial for curing this product. All measurements are made with EIT UV PowerPuck II. If you are unable to fully cure this product for
Total Energy Required	750 mJ/cm ²	215 mJ/cm ²	25 mJ/cm ²	700 mJ/cm ²	some reasons, pls email us for assistance with your curing information.

SHELF-LIFE, STORAGE, USE AND HANDLING OF THIS PRODUCT

Shelf-Life of this unopened product is a minimum of ONE (1) year from date of manufacture. Avoid direct exposure of bottle to visible light at all times. Containers should remained covered when not in use. Product should be stored in a dark cool place of 2°C to 20°C. Transfer of product into other packages void all warranties. Users should ensure all bonding surfaces are free of grease, mold release, or any contaminants, as bonding performance will be compromised. All tests for curied bonds should be carried out at ambient temperature. For safe handling of this product, please read Material Safety Data-sheet (MSDS) prior to use. Organic solvents, such as IPA, may be used to wipe away uncured material from surfaces.

EtO and GAMMA STERILIZATION (Not Applicable for this Product)

All Incure medical products are formulated to subject to standard sterilization methods, such as EtO and Gamma Radiation of 25 to 50 kGrays (cumulative). Enhanced moisture and thermal resistance of this product show excellent adhesion and bonding strength after one cycle of steam auto-clave test. Depending on bond design and structure of the application, users should test specific assemblies after subjecting them to sterilisation. Consult Incure Support Team for assistance, if your devices are subjected to more than one sterilization cycles.

NOTE

The data contained in this document are furnished for information only. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein. INCURE will not be liable for any indirect, special, incidental or consequential loss or damage arising from this INCURE product, regardless of the legal theory asserted. INCURE recommends that each user adequately test its proposed use and application before repetitive use, using this data as a guide

² ISTM - refers to Incure Standard Test Method.
³ ASTM 638 Young's Modulus test speed @5mm/min for rigid and semi-rigid materials, @50mm/min for non-rigid materials, unless otherwise specified